



#### 60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C		
	50mΩ @ V <sub>GS</sub> = 10V	18A		
60V	$63m\Omega @ V_{GS} = 4.5V$	16A		

### **Features and Benefits**

- Low R<sub>DS(ON)</sub> Ensures On-State Losses are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

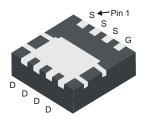
### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

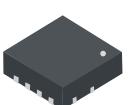
- Backlighting
- Power Management Functions
- DC-DC Converters

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.03 grams (Approximate)

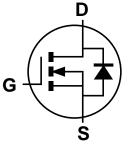


**Bottom View** 



PowerDI3333-8

Top View



**Equivalent Circuit** 

### Ordering Information (Note 5)

Part Number	Case	Packaging	
DMN6069SFGQ-7	PowerDI3333-8	2,000/Tape & Reel	
DMN6069SFGQ-13	PowerDI3333-8	3,000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



N69 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 16 = 2016) WW = Week Code (01 to 53)



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	60	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Dusin Compant (Nata 7) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	5.6 4.5	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	Steady State	$T_C = +25$ °C $T_C = +70$ °C	ID	18 14.5	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	25	Α		
Maximum Continuous Body Diode Forward Current (Note 7)			Is	2.5	Α
Avalanche Current (Note 8) L = 0.1mH			I <sub>AS</sub>	12	Α
Repetitive Avalanche Energy (Note 8) L = 0.1mH			E <sub>AS</sub>	7.2	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		$P_{D}$	0.93	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	7	134	°C/W
Themal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	82	
Total Power Dissipation (Note 7)		$P_{D}$	2.4	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State		53	
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{\theta JA}$	33	°C/W
Thermal Resistance, Junction to Case		$R_{ heta JC}$	5	
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

<sup>6.</sup> Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

<sup>8.</sup>  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_{J}$  = +25°C.

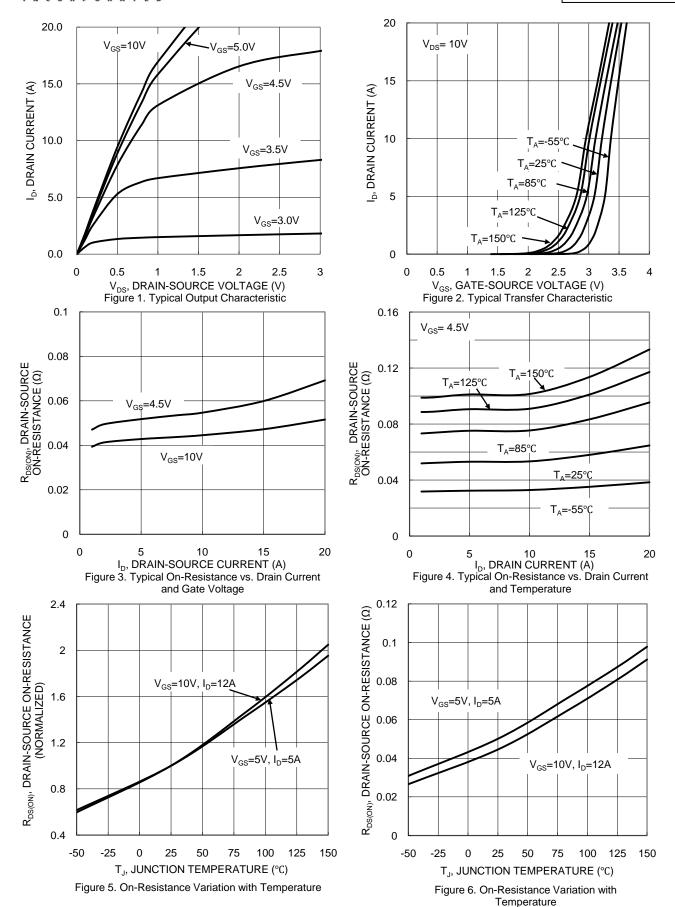


# **Electrical Characteristics** (T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	1	μΑ	$V_{DS} = 60V$ , $V_{GS} = 0V$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +150°C	I <sub>DSS</sub>	_	_	100	μΑ	$V_{DS} = 60V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Paggan	_	39	50	mΩ	$V_{GS} = 10V, I_D = 4.5A$	
Static Drain-Source On-Nesistance	R <sub>DS(ON)</sub>		47	63	11122	$V_{GS} = 4.5V, I_D = 3A$	
Diode Forward Voltage	V <sub>SD</sub>		_	1.1	V	$V_{GS} = 0V, I_S = 2.5A$	
On State Drain Current (Note 10)	I <sub>D(ON)</sub>	20			Α	$V_{DS} \ge 5V$ , $V_{GS} = 10V$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C <sub>iss</sub>		740	1,480	pF	), and ), and	
Output Capacitance	Coss	l	40	80	pF	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		28	55	pF	1 = 1.000112	
Gate Resistance	$R_g$		2.2	4	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	1	6.4	12	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	l	14	25	nC	$V_{DS} = 30V, I_{D} = 12A$	
Gate-Source Charge	$Q_{gs}$	l	2.8	5.5	nC	VDS = 30V, ID = 12A	
Gate-Drain Charge	$Q_{gd}$	1	2.3	5	nC	]	
Turn-On Delay Time	t <sub>D(ON)</sub>		3.6	10	ns		
Turn-On Rise Time	t <sub>R</sub>		5.0	10	ns	$V_{DS} = 30V, I_{D} = 12A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	12	24	ns	$V_{GS} = 10V, R_G = 6.0\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	3.3	10	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	11	22	ns	4.50 4:/4 4000/	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	5.1	10	nC	I <sub>F</sub> = 4.5A, di/dt = 100A/μs	

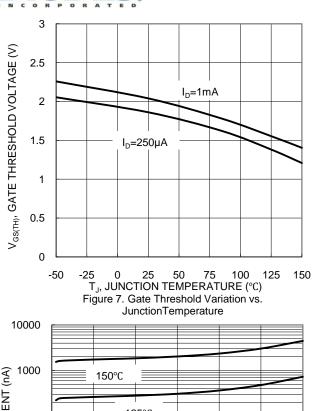
9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing. Notes:

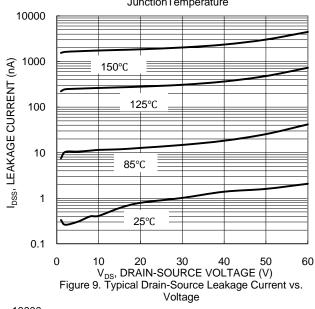


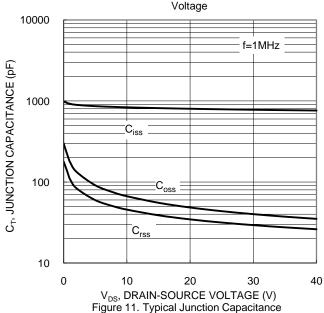


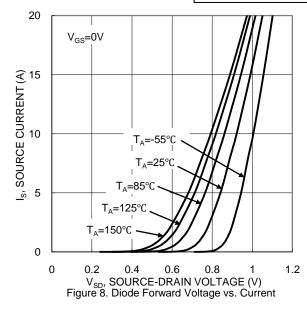


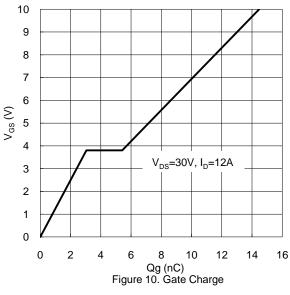


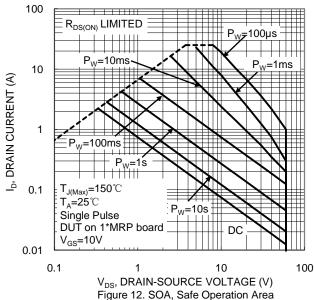




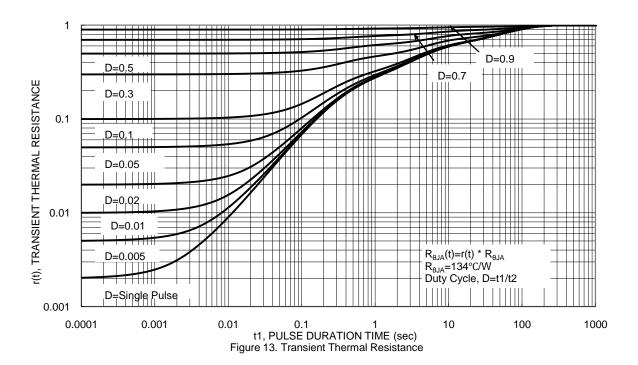










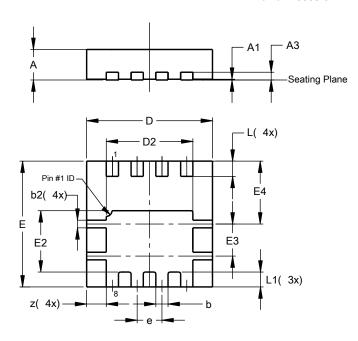




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8

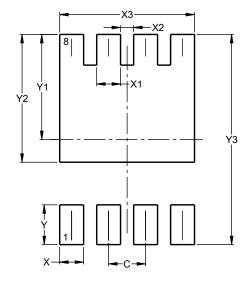


PowerDI3333-8						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	_	_	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	-	_	0.65			
L	0.35	0.45	0.40			
L1	_	_	0.39			
Z	_	_	0.515			
All Dimensions in mm						

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Υ	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		



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